ABSOCIATION CONNECTING ELECTROMICS INDUSTRIES®	IPC, Bannock	burn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar the declaratio	ration of n encom	f the substance npasses all low	s within the er level ma	e manufactur terials for w	rer listed ite hich the m	em. Note anufactu	e: if the item is an as arer has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form 7 http://www.ipc.org/IPC-175x Distrib				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					eous Materi	ials and Mfg Information				
Supplier Information															
Company name*	Company unique ID			Unique ID Authority					Response Date*						
onsemi												2024-05-19			
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email - Contact*					
Product-Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
uthorized Representative*	Title - Representative			Phone - Representative*				Email - Representative*							
Product-Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Iter	n Number	umber Mfr Item Name			Effective Date Version Manufacturing Sit		ring Site	V	/eight*	UOM	Unit Type			
	FODM	3071	SO5 3.3V 10MB			2024-05-19			LITEONFG		9	7.594	mg	Each	
Anufacturing Proccess Inform	ation					-							1		
Terminal Plating / Grid Array M	/aterial '	Ferminal Base	Alloy	J-STD-020 MSL Rating		Peak Process Body Tem		ody Temperati	rature Max Time at Peak		Temperatu	nperature Number of Reflow Cycles		cles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С	30 s		second	s 3			
comments															
evel 1 - maximum time at peak tempera	ture during so	ldering is 10-3	0 seconds												
or more information regarding materia	al composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl thalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.												
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measur
Coupling Gel	8.8	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		3.96	mg
			Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.88	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		3.96	mg
Die	0.237	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.077	mg
			Supplier	Silicon (Si)	7440-21-3		0.16	mg
Die Attach	0.009	mg	Supplier	Silver (Ag)	7440-22-4		0.007	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.002	mg
Lead Frame	17.018	mg	Supplier	Silver (Ag)	7440-22-4		0.002	mg
			Supplier	Zinc (Zn)	7440-66-6		0.02	mg
			Supplier	Iron (Fe)	7439-89-6		0.391	mg
			Supplier	Copper (Cu)	7440-50-8		16.6	mg
			Supplier	Phosphorus (P)	7723-14-0		0.005	mg
Mold Compound-Black	70.32	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4- hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		2.81	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		16.2	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		2.11	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		49.2	mg
Plating	1.16	mg	Supplier	Tin (Sn)	7440-31-5		1.16	mg
Wire Bond - Au	0.05	mg	Supplier	Gold (Au)	7440-57-5		0.05	mg